



MBRD650CT MBRD660CT

SCHOTTKY RECTIFIER

6 Amp

$I_{F(AV)} = 6.0\text{Amp}$
 $V_R = 50\text{-}60\text{V}$

Major Ratings and Characteristics

Characteristics	Values	Units
$I_{F(AV)}$ Rectangular waveform	6	A
V_{RRM}	50 - 60	V
I_{FSM} @ tp = 5 μ s sine	490	A
V_F @ 3 Apk, $T_J = 125^\circ\text{C}$ (per leg)	0.65	V
T_J range	-40 to 150	$^\circ\text{C}$

Description/ Features

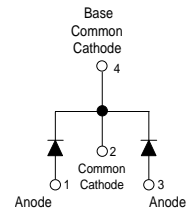
The MBRD650CT, MBRD660CT surface mount, center tap, Schottky rectifier series has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, free-wheeling diodes, battery charging, and reverse battery protection.

- Popular D-PAK outline
- Center tap configuration
- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability

Case Styles



D-PAK (TO-252AA)



Voltage Ratings

Part number	MBRD650CT	MBRD660CT
V _R Max. DC Reverse Voltage (V)	50	60
V _{RWM} Max. Working Peak Reverse Voltage (V)		

Absolute Maximum Ratings

Parameters	Value	Units	Conditions
I _{F(AV)} Max. Average Forward (Per Leg) Current * See Fig. 5 (Per Device)	3.0 6	A	50% duty cycle @ T _C = 128°C, rectangular wave form
I _{FSM} Max. Peak One Cycle Non-Repetitive Surge Current * See Fig. 7	490 75	A	5µs Sine or 3µs Rect. pulse 10ms Sine or 6ms Rect. pulse
E _{AS} Non-Repet. Aval. Energy (Per Leg)	6	mJ	T _J = 25 °C, I _{AS} = 1 Amp, L = 12 mH
I _{AR} Repetitive Avalanche Current (Per Leg)	0.6	A	Current decaying linearly to zero in 1 µsec Frequency limited by T _J max. V _A = 1.5 x V _R typical

Electrical Specifications

Parameters	Value	Units	Conditions
V _{FM} Max. Forward Voltage Drop (Per Leg) * See Fig. 1 (1)	0.7	V	@ 3A
	0.9	V	@ 6A
	0.65	V	@ 3A
	0.85	V	@ 6A
I _{RM} Max. Reverse Leakage Current (Per Leg) * See Fig. 2 (1)	0.1	mA	T _J = 25 °C
	15	mA	T _J = 125 °C
C _T Typ. Junction Capacitance (Per Leg)	145	pF	V _R = 5V _{DC} (test signal range 100Khz to 1Mhz) 25°C
L _S Typical Series Inductance (Per Leg)	5.0	nH	Measured lead to lead 5mm from package body
dv/dt Max. Voltage Rate of Change	10000	V/µs	(Rated V _R)

(1) Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications

Parameters	Value	Units	Conditions
T _J Max. Junction Temperature Range (*)	-40 to 150	°C	
T _{stg} Max. Storage Temperature Range	-40 to 150	°C	
R _{thJC} Max. Thermal Resistance (Per Leg) Junction to Case (Per Device)	6	°C/W	DC operation * See Fig. 4
	3		
R _{thJA} Max. Thermal Resistance Junction to Ambient	80	°C/W	
wt Approximate Weight	0.3 (0.01)	g (oz.)	
Case Style	D-Pak		Similar to TO-252AA
Device Marking	MBRD660CT		

(*) $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ thermal runaway condition for a diode on its own heatsink

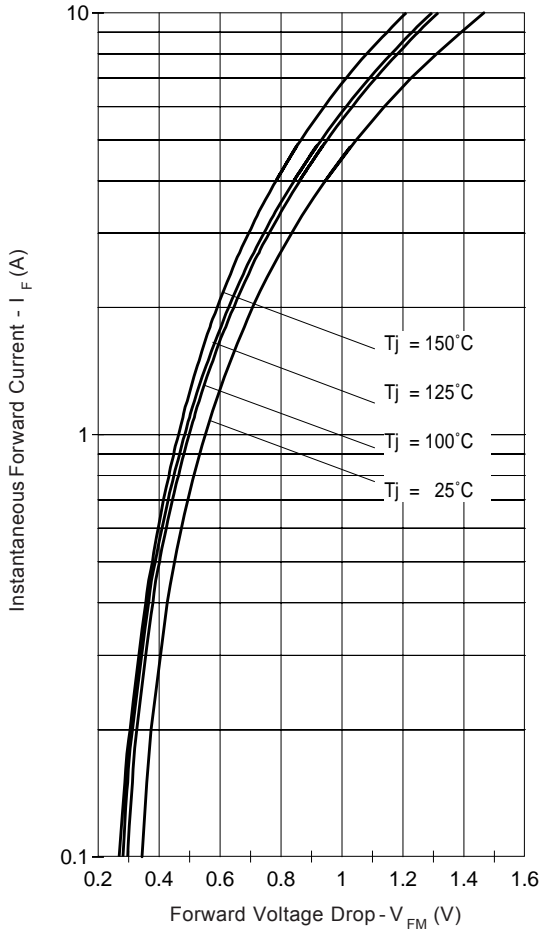


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

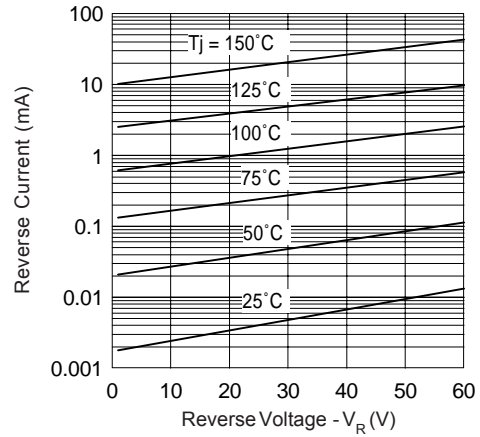


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage (Per Leg)

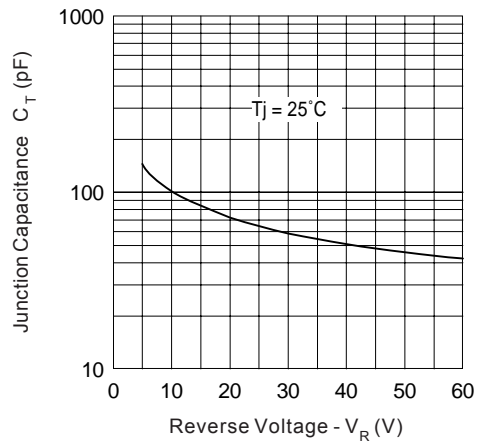


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

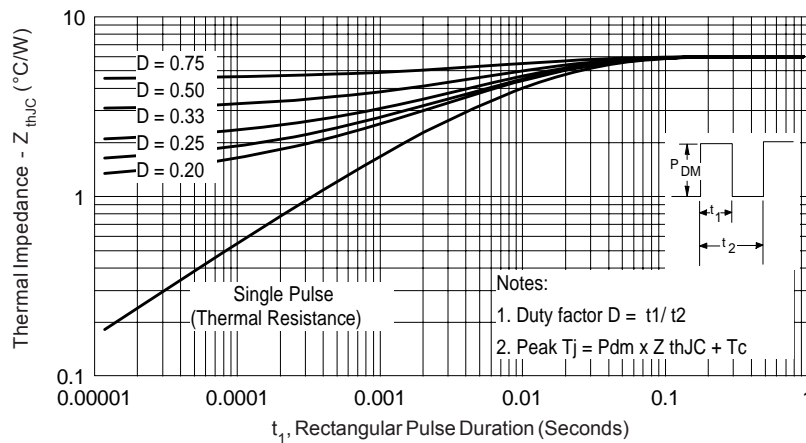


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

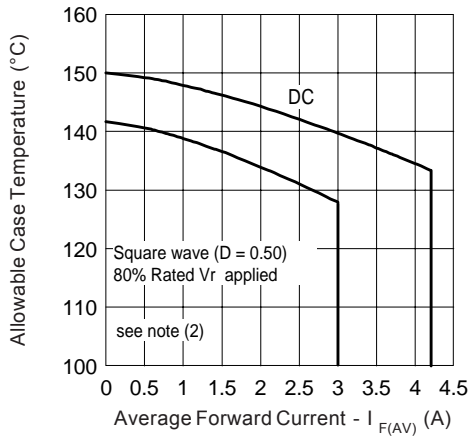


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current (Per Leg)

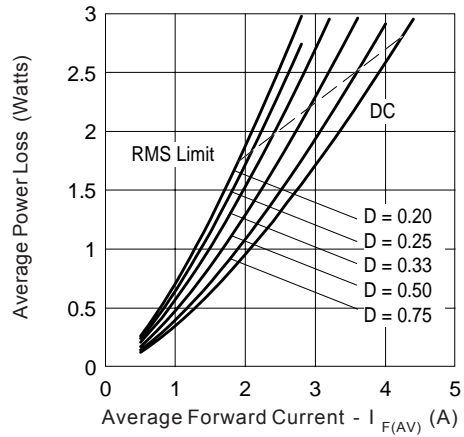


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

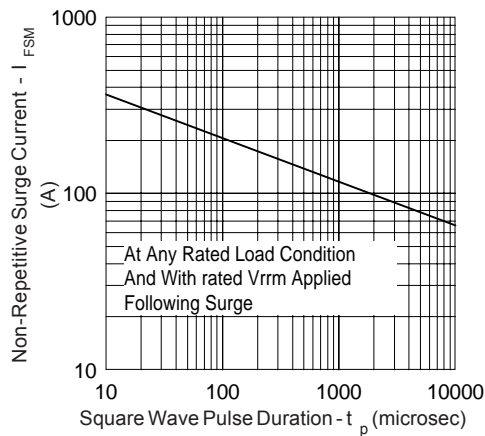


Fig. 7 - Max. Non-Repetitive Surge Current (Per Leg)

- (2) Formula used: $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$;
 $P_d = \text{Forward Power Loss} = I_{F(AV)} \times V_{FM} @ (I_{F(AV)} / D)$ (see Fig. 6);
 $P_{d_{REV}} = \text{Inverse Power Loss} = V_{R1} \times I_R (1 - D)$; $I_R @ V_{R1} = 80\% \text{ rated } V_R$

Outline Table

NOTES:

- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS]
- 3.- LEAD DIMENSION UNCONTROLLED IN L5
- 4.- DIMENSION D1, E1, L5 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.15 AND 0.25] FROM THE LEAD TIP.
- 6.- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0.15] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- 7.- DIMENSION b1 & c1 APPLIED TO BASE METAL ONLY.
- 8.- DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
A	2.18	2.30	.086	.094	
A1	-	0.15	-	.005	
b	0.64	0.89	.025	.035	
b1	0.65	0.79	.025	.031	7
b2	0.76	1.14	.030	.045	
b3	4.95	5.46	.195	.215	4
c	0.46	0.61	.018	.024	
c1	0.41	0.56	.016	.022	7
c2	0.46	0.89	.018	.035	
D	5.97	6.22	.235	.245	6
D1	5.21	-	.205	-	4
E	6.55	6.73	.250	.265	6
E1	4.92	-	.170	-	4
#	2.29	BSC	.090	BSC	
H	9.40	10.41	.370	.410	
L	1.40	1.78	.055	.070	
L1	2.74	BSC	-	0.08 REF	
L2	0.51	BSC	.020	BSC	
L3	0.89	1.27	.035	.050	4
L4	-	1.02	-	.040	
L5	1.14	1.52	.045	.060	3
#	0"	10"	0"	10"	
#1	0"	15"	0"	15"	
#2	25"	35"	25"	35"	

LEAD ASSIGNMENTS

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

HEXFEET

- 1.- GATE
- 2.- DRAIN
- 3.- SOURCE
- 4.- DRAIN

IGBT & CoPAK

- 1.- GATE
- 2.- COLLECTOR
- 3.- EMITTER
- 4.- COLLECTOR

Modified JEDEC outline TO-252AA
Dimensions in millimeters and (inches)

Part Marking Information

EXAMPLE: THIS IS A MBRD660CT
LOT CODE 8024
ASSEMBLED ON WW 02, 2000

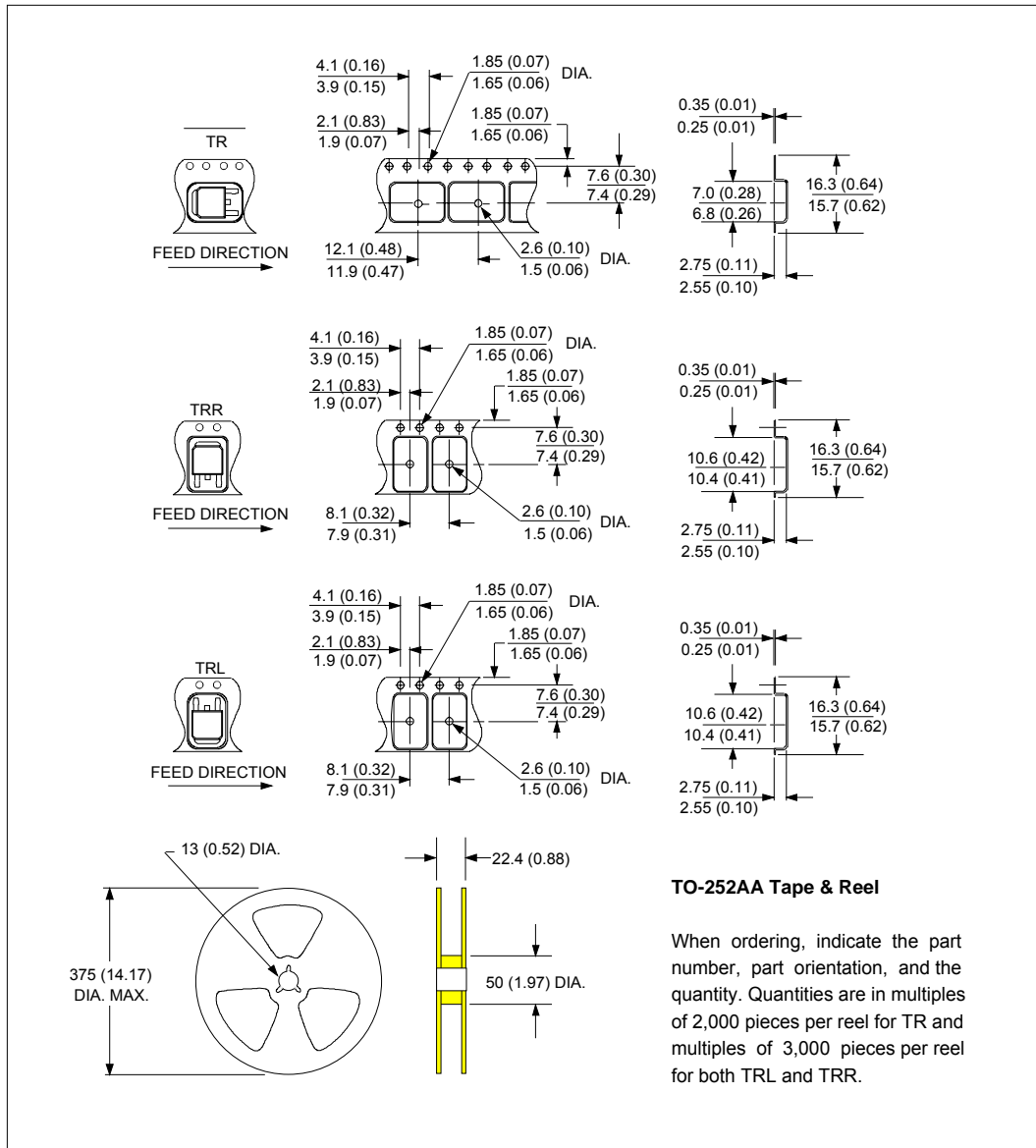
INTERNATIONAL
RECTIFIER
LOGO

ASSEMBLY
LOT CODE

PART NUMBER
MBRD660CT

DATE CODE
YEAR 0 = 2000
WEEK 02
X = SITE ID

Tape & Reel Information



Ordering Information Table

Device Code						
MBR	D	6	60	CT	TR	-
①	②	③	④	⑤	⑥	⑦
1	-	Schottky MBR Series				
2	-	D = D-Pak (TO-252AA)				
3	-	Current Rating (6 = 6A)				
4	-	Voltage Ratings				
5	-	CT = Center Tap (Dual)				
6	-	<ul style="list-style-type: none"> • none = Tube (50 pieces) • TR = Tape & Reel • TRL = Tape & Reel (Left Oriented) • TRR = Tape & Reel (Right Oriented) 				
7	-	<ul style="list-style-type: none"> • none = Standard Production • PbF = Lead-Free 				

50 = 50V
 60 = 60V

Data and specifications subject to change without notice.
 This product has been designed and qualified for AEC Q101 Level.
 Qualification Standards can be found on IR's Web site.



Notice

The products described herein were acquired by Vishay Intertechnology, Inc., as part of its acquisition of International Rectifier's Power Control Systems (PCS) business, which closed in April 2007. Specifications of the products displayed herein are pending review by Vishay and are subject to the terms and conditions shown below.

Specifications of the products displayed herein are subject to change without notice. Vishay Intertechnology, Inc., or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Vishay's terms and conditions of sale for such products, Vishay assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of Vishay products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Vishay for any damages resulting from such improper use or sale.

International Rectifier®, IR®, the IR logo, HEXFET®, HEXSense®, HEXDIP®, DOL®, INTERO®, and POWIRTRAIN® are registered trademarks of International Rectifier Corporation in the U.S. and other countries. All other product names noted herein may be trademarks of their respective owners.